

# HA17384PS/FP, HA17385PS/FP

Preliminary

## Current Mode PWM Control Switching Regulator ICs

### Description

The HA17384 series is a control IC for PWM (pulse width modulation) switching regulator. These ICs are suitable for primary control system, and the standby current are as small as  $500\text{ }\mu\text{A}$  (max.) These ICs enable the regulator set size to miniaturize, and to improve power efficiency of these sets. The HA17384 series is able to drive the POWER MOS FET directly and have higher switching frequency of up to 500 KHz max.

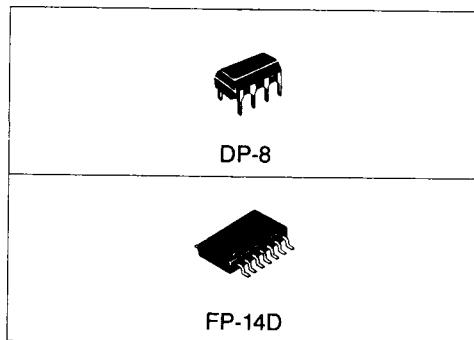
The two types of packages are DIP 8 and SOP 14 are provided for ICs.

### Functions

- 5V reference voltage circuit
- Triangular waveform oscillation circuit
- PWM comparator circuit
- Output driver circuit (totem pole output)
- Error amp circuit
- Current sense comparator with 1 pulse latch
- Under voltage lock out protection

### Features

- High speed switching:  
 $t_r = 50\text{nsec}$  (typ.) (at 15V swing)  
 $t_f = 50\text{nsec}$  (typ.) (at 15V swing)
- Low power dissipation:  
 $500\mu\text{A}$  max. in standby state  
 $17\text{mA}$  max. in active state (at  $V_{IN} = 15\text{V}$ )
- Under voltage lockout protection:  
high threshold voltage: ..... HA17384—16V  
..... HA17385—10V  
low threshold voltage: ..... HA17384—10V  
..... HA17385—8V
- Drive the POWER MOS FET directly:  
output peak current 1.5A max.
- Output double pulse protection with a 1 pulse latched overcurrent protection circuit



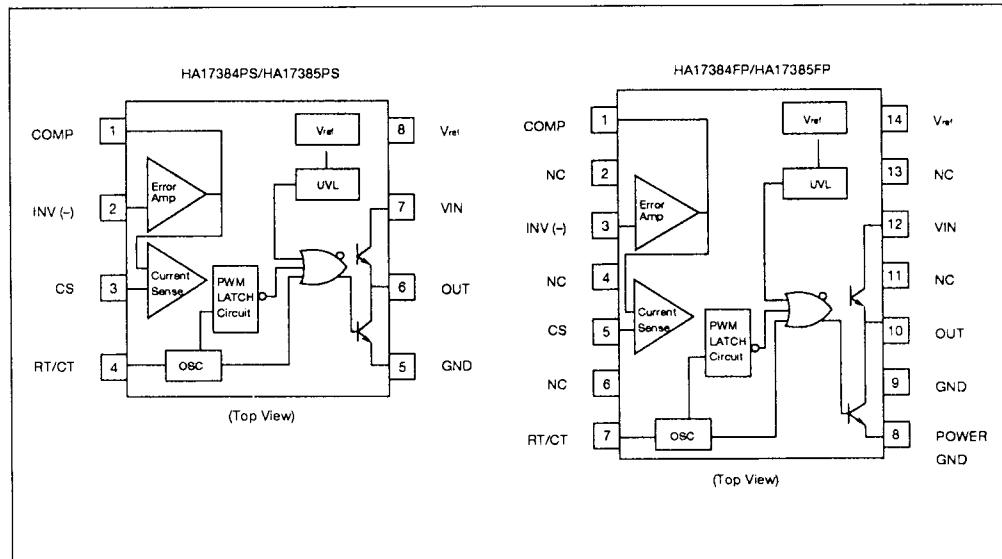
### Ordering Information

| Type No.  | Package |
|-----------|---------|
| HA17384PS | DP-8    |
| HA17384FP | FP-14D  |
| HA17385PS | DP-8    |
| HA17385FP | FP-14D  |

### Pin Functions

| Symbol           | Pin No.         |                 | Functions                         |
|------------------|-----------------|-----------------|-----------------------------------|
|                  | 384PS/<br>385PS | 384FP/<br>385FP |                                   |
| COMP             | 1               | 1               | Error amp. compensation           |
| INV (-)          | 2               | 3               | Error amp. input (-)              |
| CS               | 3               | 5               | Current sense                     |
| RT/CT            | 4               | 7               | Timing register, Timing capacitor |
| GND              | 5               | 8               | Ground                            |
| OUT              | 6               | 10              | Pulse output                      |
| V <sub>IN</sub>  | 7               | 12              | Input voltage                     |
| V <sub>REF</sub> | 8               | 14              | Reference voltage (5V) output     |
| P-GND            | —               | 9               | Power Ground                      |

## Block Diagram

Absolute Maximum Ratings ( $T_a = 25^\circ\text{C}$ )

| Item                        | Symbol           | Rating                              |                  | Unit |
|-----------------------------|------------------|-------------------------------------|------------------|------|
|                             |                  | HA17384PS/385PS                     | HA17384FP/385FP  |      |
| Power Supply Voltage        | VIN              | + 40                                | + 40             | V    |
| Collector Current           | DC               | l <sub>dc</sub> push pull 0.3       | push pull 0.3    | A    |
|                             | Peak             | l <sub>opeak</sub> push pull 1.5*** | push pull 1.5*** | A    |
| Error Input Voltage         | V <sub>E</sub>   | -0.3 ~ + 6.3                        | -0.3 ~ + 6.3     | V    |
| Comparator Input Voltage    | V <sub>C</sub>   | -0.3 ~ + 6.3                        | -0.3 ~ + 6.3     | V    |
| Error Amp Output Current    | I <sub>E</sub>   | 10                                  | 10               | mA   |
| Power Dissipation           | P <sub>T</sub>   | 830*                                | 830*             | mW   |
| Operation Temperature Range | T <sub>opr</sub> | -20 to + 85                         | -20 to + 85      | °C   |
| Storage Temperature Range   | T <sub>stg</sub> | -55 ~ + 125                         | -55 ~ + 125      | °C   |

The absolute maximum ratings are limiting values, to be applied individually, beyond which the device may be permanently damaged. Functional operation under any of these conditions is not guaranteed. Exposing a circuit to its absolute maximum rating for extended periods of time may affect the device's reliability.

\* This is the allowable loss value for a maximum rating up to  $T_a \leq 25^\circ\text{C}$ . If more than, 8.3mW/°C derating must be performed.

\*\* Allowable temperature of IC junction,  $T_j$  (max.), is as shown below.

$$T_j(\text{max.}) = \theta_j - a \cdot P_c(\text{max.}) + T_a$$

( $\theta_j$  - a is thermal resistance value during board mounting, and  $P_c$  (max.) maximum value of IC power dissipation.)

Therefore, to keep  $T_j$  (max.) 125°C, wiring density and board material must be selected according to the board thermal conductivity shown below.

Be careful that the value of  $P_c$  (max.) does not exceed that of  $P_T$ .

\*\*\* Value at a current flow period of 300nsec.

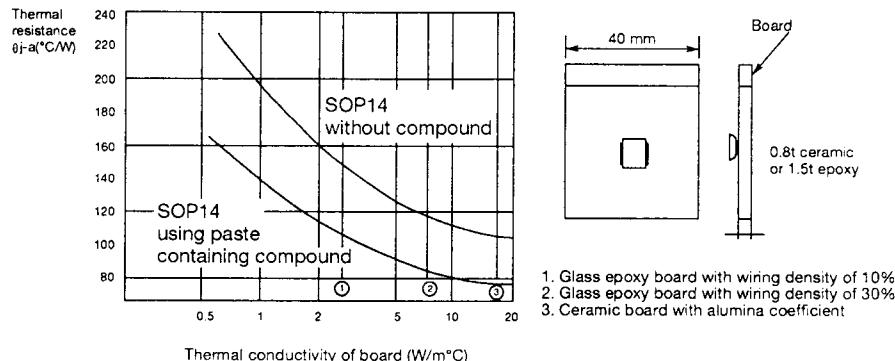


Figure 1. Thermal resistance of SOP

**Electrical Characteristics (VIN = 15V, Ta = 25°C, RT = 10KΩ, CT = 3300pF)**

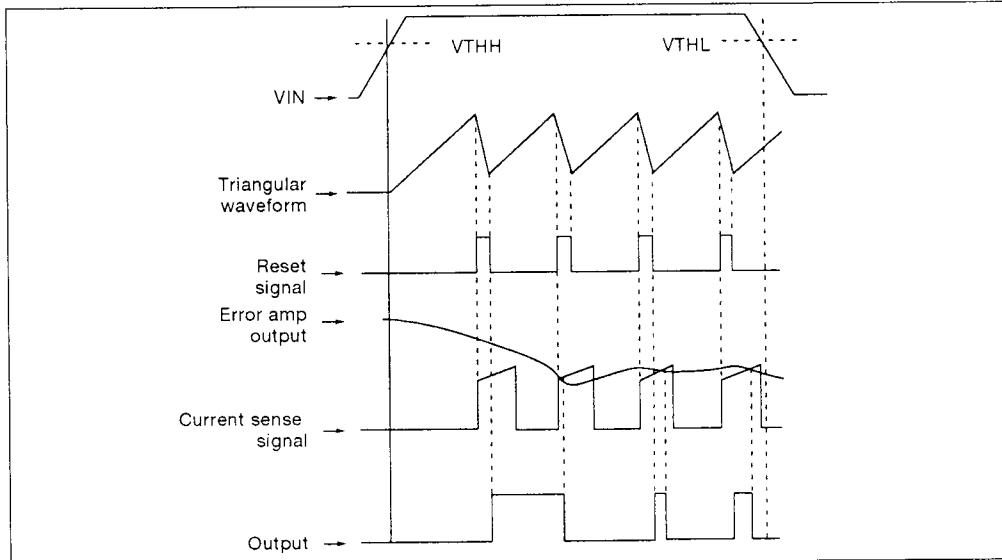
| Section                                 | Item                         | Symbol              | Test Condition   | min. | typ. | max. | Unit | Note |
|---|------------------------------|---------------------|--|------|------|------|------|------|
| Reference Section                       | Output Voltage               | Vref                | Io = 1mA   | 4.85 | 5.00 | 5.15 | V    |      |
|   | Line Regulation              | Line                | VIN = 12 to 40V  | —    | 6    | 20   | mV   |      |
|   | Load Regulation              | Load                | Io = 1 to 20mA   | —    | 6    | 25   | mV   |      |
|   | Temperature Stability        | VR <sub>TC</sub>    | No load  | —    | 0.2  | —    | %    |      |
|   | Output Noise Voltage         | V <sub>N</sub>      | 10Hz ≤ f ≤ 10KHz   | —    | 50   | —    | µV   |      |
|   | Short Circuit Current        | I <sub>OS</sub>     | —  | 30   | 100  | 180  | mA   |      |
| Triangular Waveform Oscillation Section | Initial Accuracy             | f <sub>dev</sub>    | —  | 47   | 52   | 57   | KHz  |      |
|   | Voltage Stability            | f <sub>T</sub>      | 12V < VIN < 40V  | —    | 0.2  | 1    | %    |      |
|   | Temperature Range            | Δf                  | -20°C ≤ Ta ≤ 85°C  | —    | 5    | —    | %    |      |
|   | Amplitude                    | V <sub>osc</sub>    | ④ pin (⑦ pin)<br>peak to peak                                | —    | 1.7  | —    | V    |      |
|   | Input Voltage                | V <sub>EiH</sub>    | V① = 2.5V  | 2.42 | 2.50 | 2.58 | V    |      |
| Error Amp Section                       | Input Bias Current           | I <sub>B1</sub>     | —  | —    | 0.3  | 2    | µA   |      |
|   | Open-Loop Voltage Gain       | A <sub>vD</sub>     | 2V ≤ V <sub>O</sub> ≤ 4V                                     | 65   | 90   | —    | dB   |      |
|   | Unity Gain Bandwidth         | B <sub>w</sub>      | —  | 0.7  | 1.0  | —    | MHz  |      |
|   | Power Supply Rejection Ratio | P <sub>SRR</sub>    | 12V ≤ V <sub>CC</sub> ≤ 40V                                  | 60   | 70   | —    | dB   |      |
|   | Output Sink Current          | I <sub>sink</sub>   | V② (V③) = 2.7V,<br>V① = 1.1V                                 | 2    | 6    | —    | mA   | 1    |
|   | Output Source Current        | I <sub>source</sub> | V② (V③) = 2.3V,<br>V① = 5V                                   | 500  | 800  | —    | µA   | 1    |
|   | V <sub>O</sub> H High        | V <sub>O</sub> H    | V② (V③) = 2.3V,<br>R <sub>L</sub> = 15KΩ to ground           | 5    | 6    | —    | V    | 1    |
|   | V <sub>O</sub> L Low         | V <sub>O</sub> L    | V② (V③) = 2.7V,<br>R <sub>L</sub> = 15KΩ to V <sub>ref</sub> | —    | 0.7  | 1.1  | V    | 1    |
| Comparator Section                      | Gain                         | —                   | —  | 2.85 | 3    | 3.15 | V/V  |      |
|   | Input Threshold Voltage      | V <sub>iH</sub>     | —  | 0.9  | 1.0  | 1.1  | V    |      |
|   | Input Bias Current           | I <sub>B2</sub>     | —  | —    | 2    | 10   | µA   |      |
|   | Delay to Output              | t <sub>r1</sub>     | —  | —    | 150  | 300  | ns   |      |

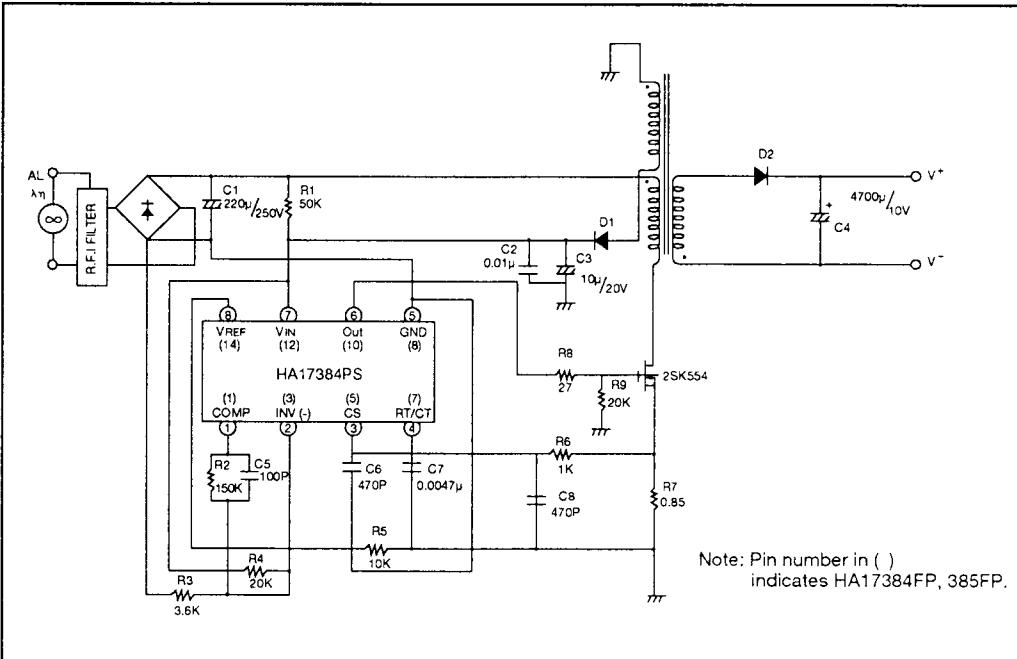
## Electrical Characteristics (VIN = 15V, Ta = 25°C, RT = 10KΩ, CT = 3300pF) (Cont'd.)

| Section               | Item                 | Symbol           | Test Condition  | min. | typ. | max. | Unit | Note |
|-----------------------|----------------------|------------------|---|------|------|------|------|------|
| Output Section        | Output High Level    | V <sub>OH</sub>  | I <sub>sink</sub> 20mA  | 13   | 13.5 | —    | V    |      |
|                       | Output High Level    | V <sub>OH</sub>  | I <sub>sink</sub> 200mA   | 12   | 13.5 | —    | V    |      |
|                       | Output Low Level     | V <sub>OL</sub>  | I <sub>source</sub> 20mA  | —    | 0.1  | 0.4  | V    |      |
|                       | Output Low Level     | V <sub>OL</sub>  | I <sub>source</sub> 200mA   | —    | 1.5  | 2.2  | V    |      |
|                       | Rise Time            | t <sub>r</sub>   | C <sub>L</sub> = 1nF  | —    | 50   | 150  | ns   |      |
|                       | Fall Time            | t <sub>f</sub>   | C <sub>L</sub> = 1nF  | —    | 50   | 150  | ns   |      |
|                       | Output Leak Current  | I <sub>LO</sub>  | V <sub>CC</sub> = 14V, V <sub>(6)</sub><br>(V <sub>10</sub> = 0V, UVL active)           | —    | 0.01 | 10   | μA   | 1    |
|                       | High Level Threshold | V <sub>THH</sub> |   | 14.5 | 16   | 17.5 | V    |      |
|                       | Low Level Threshold  | V <sub>THL</sub> |   | 8.5  | 10   | 11.5 | V    |      |
| Total Current Section | Standby Current      | I <sub>CS</sub>  |   | —    | 250  | 500  | μA   |      |
|                       | Active Current       | I <sub>CL</sub>  | V <sub>(2)</sub> (V <sub>(3)</sub> ) = 0V,<br>V <sub>(3)</sub> (V <sub>(5)</sub> ) = 0V | —    | 10   | 15   | mA   | 1    |

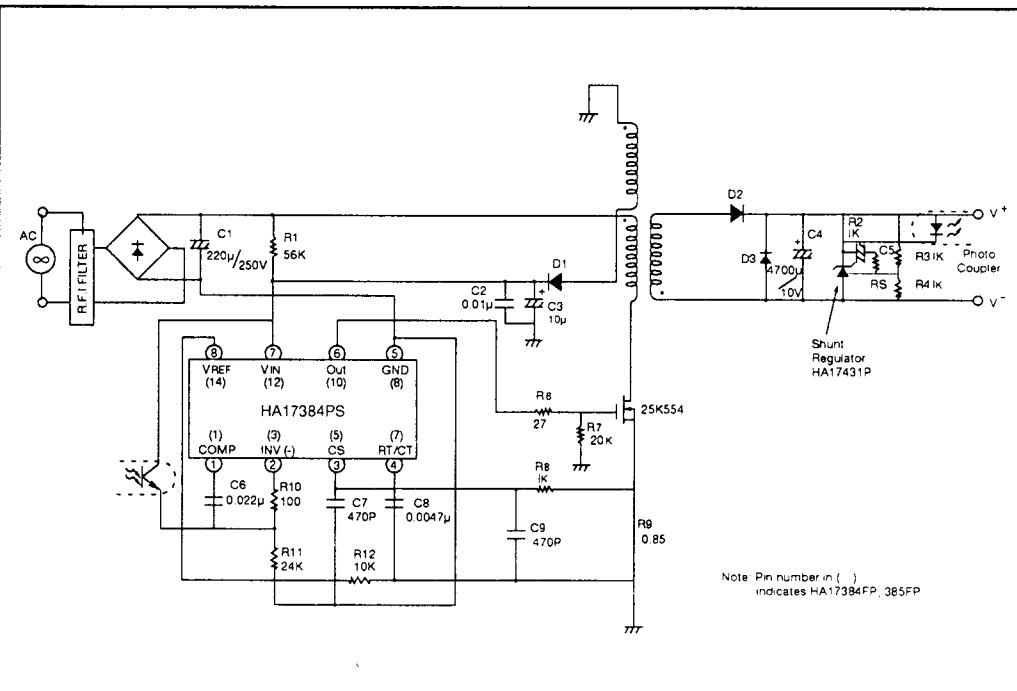
Note: 1. Pin number in ( ) indicates HA17384FP, HA17385FP.

## Waveform Timing





### System Configuration (Primary Current Sense Type)



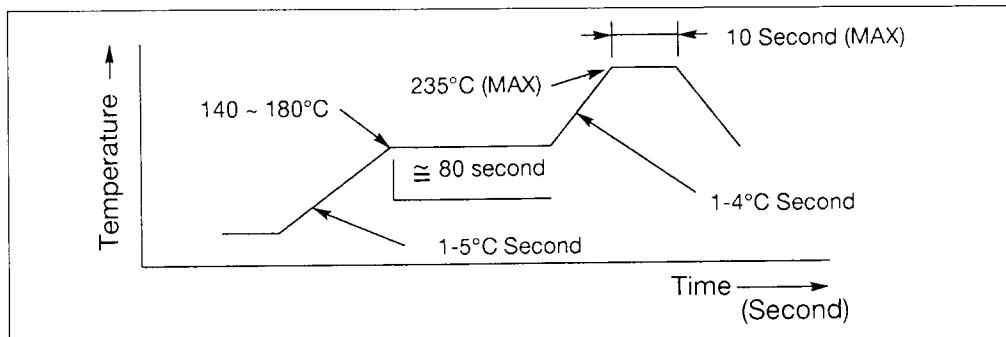
#### **System Configuration (Secondary Current Sense Type)**



### Solder Mounting Method

- 1). Small and light surface-mount packages require special attentions on solder mounting. On solder mounting, pre-heating before soldering is needed. The following figure shows an example of infrared rays reflow.

- 2). The difference of thermal expansion coefficient between mounting substrates and IC lead may cause a failure like solder peeling or solder wet, and electrical characteristics may change by thermal stress. Therefore, mounting should be done after sufficient confirmation for especially in case of ceramic substrates.



**An Example of Infrared Rays Reflow Conditions**